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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/827,287	04/20/2004	Koji Mishima	2004_0611	2623
513 75	90 06/02/2005		EXAM	INER
	H, LIND & PONACE	LEADER, W	LEADER, WILLIAM T	
2033 K STREE	T N. W.			
SUITE 800 WASHINGTON, DC 20006-1021			ART UNIT	PAPER NUMBER
			1742	

DATE MAILED: 06/02/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

•	A	pplication No.	Applicant(s)			
Office Action Summary		0/827,287	MISHIMA ET AL.			
		xaminer	Art Unit			
		/illiam T. Leader	1742			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status			·			
1) Responsive to communication	(s) filed on <u>15 Marc</u>	<u>h 2005</u> .				
2a)⊠ This action is FINAL.	☐ This action is FINAL. 2b)☐ This action is non-final.					
	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the	practice under Ex p	parte Quayle, 1935 C.D. 11, 45	3 O.G. 213.			
Disposition of Claims						
4) Claim(s) <u>5-8</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed						
6) Claim(s) <u>5-8</u> is/are rejected.						
7) Claim(s) is/are objected						
8) Claim(s) are subject to	restriction and/or ele	ection requirement.				
Application Papers						
9)☐ The specification is objected to by the Examiner.						
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.						
		•				
Attachment(s)  1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)						
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date						
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date  5) Notice of Informal Patent Application (PTO-152)  6) Other:						
S. Patent and Trademark Office						

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## **DETAILED ACTION**

1. Receipt of the papers filed on March 15, 2005, is acknowledged. Applicant has canceled claims 1-4 and presented new claims 5-8.

2. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 5. Claims 5-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Talieh (6,676,822), of record, combined with Ashjaee et al (6,482,307), newly cited.

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6. As indicated in the previous office action, the Talieh patent is directed to a method for electrochemical deposition of a metal onto a semiconductor wafer. As shown in figures 1A and 1B, the wafer is positioned to face anode 30. A pad 32 is positioned between the anode and wafer. A plating liquid is supplied through openings in the anode plate to the pad. A cathode contact 28 provides plating current to the wafer. As shown in figure 1A, both the wafer and pad rotate. The widths of the pad 32 and supporting portion of the anode are smaller than the diameter of the wafer. Consequently, as the pad and wafer rotate, the central portion of the surface of the substrate faces the anode for a longer time than the outer peripheral portion.

- 7. Applicant now recites in claim 5 that the substrate has fine trenches which are covered by a seed layer. Talieh discloses the deposition of a layer of metal on the face of a semiconductor wafer over a barrier/seed layer (column 1, lines 16-20). Talieh additionally discloses that the metal is deposited into trenches (column 1, lines 27-31)
- 8. Claim 5 differs from the process of Talieh by reciting that a gap is formed between the substrate and the plating liquid impregnation material and that electric current is applied without bringing the substrate into contact with the plating liquid impregnation material. The Ashjaee et al patent is directed to a method for electroplating and electropolishing semiconductor wafers. As shown in figure 4, pad 8, which corresponds to applicant's liquid impregnation material, is disposed between an anode and semiconductor wafer 22. A gap 34 between the pad 8 and the wafer 22 is provided. This gap corresponds to the gap now recited by applicant. Ashjaee et al teach that gap 34 may be adjusted so that one can achieve just plating, or plating and polishing.
- 9. The prior art of record is indicative of the level of skill of one of ordinary skill in the art.

  It would have been obvious at the time the invention was made to have provided a gap between

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pad 32 and the wafer of Talieh as taught by Ashjaee et al because plating without polishing in addition to plating and polishing would have been performed. It would have additionally been obvious in the process of Ashjaee et al to have provided a pad and anode larger than the wafer as taught by Talieh because more uniform deposition would have been obtained as the wafer and pad are moved relative to each other.

- 10. As shown in figure 1A of Talieh and noted above, the substrate is moved by rotation. This meets the limitation of claim 6. The anode is also moved by rotation. This meets the limitation of claim 7. As shown in figure 4B, anode 214 may translate with respect to the substrate. This meets the limitation of claim 8.
- 11. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to William T. Leader whose telephone number is 571-272-1245.

The examiner can normally be reached on Mondays-Thursdays and alternate Fridays, 7:30-4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Roy King, can be reached on 571-272-1244. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

William Leader May 25, 2005 ROY KING
SUPERVISORY PATENT EXAMINER
TECHNGLOGY CENTER 1700